Tender of 5-year RMB HKSAR Institutional Government Bonds to be held on December 5

The following is issued on behalf of the Hong Kong Monetary Authority:

The Hong Kong Monetary Authority (HKMA), as representative of the Hong Kong Special Administrative Region Government (HKSAR Government), announced today (November 29) that a tender of 5-year RMB Institutional Government Bonds (Bonds) under the Infrastructure Bond Programme will be held on December 5, 2024 (Thursday) for settlement on December 9, 2024 (Monday).

A total of RMB1.0 billion 5-year RMB Bonds will be tendered. The Bonds will mature on December 10, 2029 and will carry interest at the rate of 2.37 per cent per annum payable semi-annually in arrear.

Tender is open only to Primary Dealers appointed under the Infrastructure Bond Programme. Anyone wishing to apply for the Bonds on offer can do so through any of the Primary Dealers on the latest published list, which can be obtained from the Hong Kong Government Bonds website at www.hkgb.gov.hk. Each tender must be for an amount of RMB50,000 or integral multiples thereof.

Tender results will be published on the HKMA's website, the Hong Kong Government Bonds website, Bloomberg (GBHK <GO>) and Refinitiv (IBPGSBPINDEX). The publication time is expected to be no later than 3pm on the tender day.

HKSAR Institutional Government Bonds Tender Information

Tender information of 5-year RMB HKSAR Institutional Government Bonds:

Issue Number : 05GB2912002

Stock Code : 84596 (HKGB2.37 2912-R)

Tender Date and December 5, 2024 (Thursday)

Time 9.30 am to 10.30 am

Issue and

: December 9, 2024 (Monday) Settlement Date

Amount on Offer : RMB1.0 billion

Maturity : 5 years

Maturity Date : Monday, 10 December 2029

2.37 per cent p.a. payable semi-annually in Interest Rate

arrear

June 9 and December 9 in each year, commencing on the Issue Date up to and including the Maturity Date, subject to adjustment in accordance with the terms of the Institutional Issuances Information

Interest Payment Dates

Memorandum of the Infrastructure Bond Programme and Government Sustainable Bond Programme (Information Memorandum) published on the Hong Kong Government Bonds website.

Method of Tender : Competitive tender

> Each competitive tender must be for an amount of RMB50,000 or integral multiples : thereof. Any tender applications for the

Tender Amount Bonds must be submitted through a Primary

> Dealer on the latest published list. Please see the Information Memorandum

Other Details : available on the Hong Kong Government Bonds

website or approach Primary Dealers.

Expected

commencement date

of dealing on

December 10, 2024 (Tuesday) the Stock

Exchange of Hong Kong

Limited

The Bonds will be issued under the

institutional part of the Infrastructure Bond Programme. Proceeds will be invested

Use of Proceeds

: in infrastructure projects in accordance with the Infrastructure Bond Framework published on the Hong Kong Government Bonds

website.